LCD / LCM SPECIFICATION



WINSTAR Display Co.,Ltd. 華凌光電股份有限公司

CUSTOMER



WEB: https://www.winstar.com.tw E-mail: sales@winstar.com.tw

SPECIFICATION

MODULE NO.:	WO12864F	K-TMI#
APPROVED BY:		
(FOR CUSTOMER USE ONLY)	PCB VERSION:	DATA:

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY

VERSION	DATE	REVISED PAGE NO.	SUMMARY	
			Modify	High
A	2020/06/08		Temperature/	
			Humidity storage	

Winstar Display Co., LTD MODLE NO: 華凌光電股份有限公司						
REC	ORDS OF REV	ISION		DOC. FIRST ISSUE		
VERSION DATE REVISED PAGE NO.		SUMMARY				

2020/04/14

2020/06/08

0

A

First issue

Humidity storage

Modify High Temperature/

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1. Module Classification Information

K W O 12864 <u>#</u>

① Brand: WINSTAR DISPLAY CORPORATION

② Display Type: $H\rightarrow$ Character Type, $G\rightarrow$ Graphic Type, $X\rightarrow$ TAB Type, $O\rightarrow$ COG Type

③ Display Font: 128 * 64 dot

Model serials no.

⑤ Backlight Type: N→Without backlight $T\rightarrow$ LED, White L→LED, Full color

> B→EL, Blue green A→LED, Amber J→DIP LED,Blue D→EL. Green $R \rightarrow LED$. Red K→DIP LED, White

W→EL, White O→LED, Orange E→DIP LED, Yellow Green

M→EL, Yellow Green G→LED, Green H→DIP LED, Amber F→CCFL, White P→LED, Blue I→DIP LED, Red

Y→LED, Yellow Green $X\rightarrow$ LED, Dual color G→LED. Green C→LED. Full color

⑥ LCD Mode : B→TN Positive, Gray V→FSTN Negative, Blue

> N→TN Negative, T→FSTN Negative, Black

L→VA Negative D→FSTN Negative (Double film)

H→ HTN Positive, Gray F→FSTN Positive I→HTN Negative, Black K→FSC Negative U→HTN Negative, Blue S→FSC Positive

M→STN Negative, Blue E→ISTN Negative, Black G→STN Positive, Gray C→CSTN Negative, Black Y→STN Positive, Yellow Green A→ASTN Negative, Black

A→Reflective, N.T, 6:00 H→Transflective, W.T,6:00 ② LCD Polarize

Type/ Temperature D→Reflective, N.T, 12:00 K→Transflective, W.T,12:00 range/ View G→Reflective, W. T, 6:00 $C \rightarrow Transmissive, N.T,6:00$

J→Reflective, W. T, 12:00 F→Transmissive, N.T,12:00 B→Transflective, N.T,6:00 I→Transmissive, W. T, 6:00

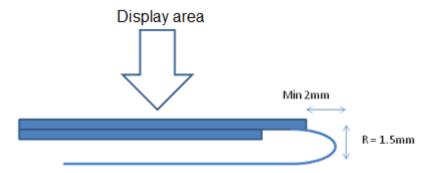
> E→Transflective, N.T.12:00 L→Transmissive, W.T,12:00

Special Code #:Fit in with the ROHS Directions and regulations

direction

2.Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8) Winstar have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9) Winstar have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Winstar have the right to modify the version.)
- (10) To ensure the stability of the display screen, please apply screen saver after showing 30 mins of fixed display content.
- (11) The limitation of FPC bending



(12)Please heat up a little the tape sticking on the components when removing it; otherwise the components might be damaged.

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3.General Specification

Item	Dimension	Unit				
Number of dots	128 x 64	_				
Module dimension	89.7 x 49.8 x 6.0	mm				
View area	66.8 x 35.5	mm				
Active area	63.98 x 31.98	mm				
Dot size	0.48 x 0.48	mm				
Dot pitch	0.50x 0.50	mm				
LCD type	STN Negative, Blue Transmissive (In LCD production, It will occur slightly color only guarantee the same color in the same batch.)					
Duty	1/65duty , 1/9 Bias					
View direction	6 o'clock	6 o'clock				
Backlight Type	LED ,White					
IC	ST7565V					

4.Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	T_{OP}	-20	_	+70	$^{\circ}\!\mathbb{C}$
Storage Temperature	T_{ST}	-30	_	+80	$^{\circ}\!\mathbb{C}$
Power Supply Voltage	V_{SS}	-3.6	_	+0.3	V
Power supply voltage (VDD standard)	V5, VOUT	-13.5	_	+0.3	V
Power supply voltage (VDD standard)	V1, V2, V3, V4	V5	_	+0.3	V

5.Electrical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	V_{DD} - V_{SS}	_	2.8	3.0	3.2	V
		Ta=-20°C	_	_	_	V
Supply Voltage For LCD	V_{OP}	Ta=25°℃	9.3	9.5	9.7	V
*Note		Ta=70°C	_	_	_	V
Input High Volt.	V_{IH}	_	$0.8~\mathrm{V_{DD}}$	_	V_{DD}	V
Input Low Volt.	$V_{\rm IL}$	_	V_{SS}	_	$0.2~\mathrm{V_{DD}}$	V
Output High Volt.	V _{OH}	_	$0.8~\mathrm{V_{DD}}$	_	V_{DD}	V
Output Low Volt.	V _{OL}	_	V_{SS}	_	$0.2~\mathrm{V_{DD}}$	V
Supply Current	I_{DD}	V _{DD} =3.0V	_	_	2.0	mA

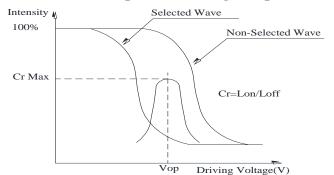
Please kindly consider to design the Vop to be adjustable while programing the software to match LCD contrast tolerance

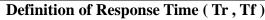
\ \ \ WINSTAR WO12864K-TMI# 第7頁,共22頁

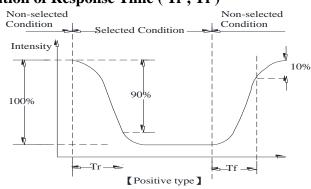
6.Optical Characteristics

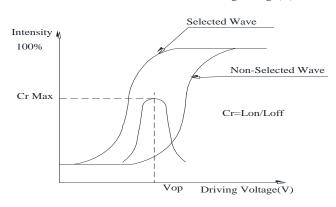
Item Symbol		Condition	Min	Тур	Max	Unit
	θ	CR≧2	0	_	20	$\Psi = 180^{\circ}$
View Amele	θ	CR≧2	0	_	40	$\Psi = 0^{\circ}$
View Angle	θ	CR≧2	0	_	30	$\Psi = 90^{\circ}$
	θ	CR≧2	0	_	30	$\Psi = 270^{\circ}$
Contrast Ratio	CR	_	_	3	_	_
D	T rise	_	_	200	300	ms
Response Time	T fall	_	_	250	350	ms

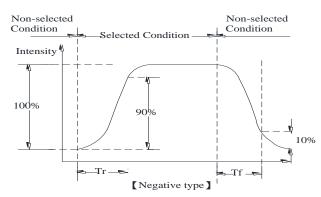
Definition of Operation Voltage (Vop)









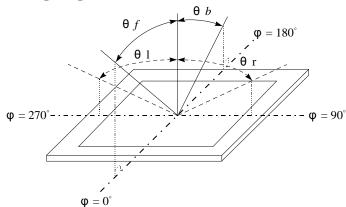


Conditions:

Operating Voltage: Vop Frame Frequency: 64 HZ Viewing Angle(θ , ϕ): 0° , 0°

Driving Waveform: 1/N duty, 1/a bias

Definition of viewing angle($CR \ge 2$)



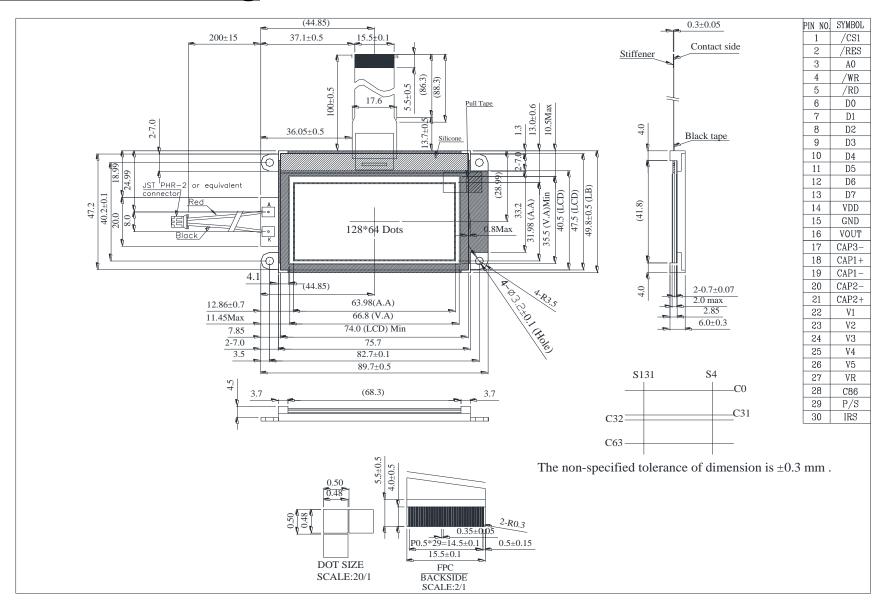
7.Interface Pin Function

Pin No.	Symbol	Description
1	/CS1	This is the chip select signal. When /CS1 = "L", then the chip select becomes active, and data/command I/O is enabled.
2	/RES	I When /RES is set to "L," the settings are initialized. The reset operation is performed by the /RES signal level.
3	A0	This is connect to the least significant bit of the normal MPU address bus, and it determines whether the data bits are data or a command. A0 = "H": Indicates that D0 to D7 are display data. A0 = "L": Indicates that D0 to D7 are control data
4	/WR	 When connected to an 8080 MPU, this is active LOW. (R/W) This terminal connects to the 8080 MPU /WR signal. The signals on the data bus are latched at the rising edge of the /WR signal. When connected to a 6800 Series MPU: This is the read/write control signal input terminal. When R/W = "H": Read. When R/W = "L": Write.
5	/RD	 When connected to an 8080 MPU, this is active LOW. (E) This pin is connected to the /RD signal of the 8080 MPU, and the ST7565V series data bus is in an output status when this signal is "L". When connected to a 6800 Series MPU, this is active HIGH. This is the 6800 Series MPU enable clock input terminal.
6	D0	
7	D1	This is an 8-bit bi-directional data bus that connects to an 8-bit or 16-bit standard
8	D2	MPU data bus.
9	D3	When the serial interface is selected $(P/S = "L")$:
10	D4	D7: serial data input (SI); D6: the serial clock input (SCL).
11	D5	D0 to D5 are set to high impedance.
12	D6	When the chip select is not active, D0 to D7 are set to high impedance.
13	D7	
14	VDD	Shared with the MPU power supply terminal Vcc.
15	GND	This is a 0V terminal connected to the system GND.
16	VOUT	DC/DC voltage converter. Connect a capacitor between this terminal and VSS.
17	CAP3-	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP1+ terminal.
18	CAP1+	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP1-terminal.

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19	CAP1-	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP1+
		terminal.
20	CAP2-	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP2-
20	CAI 2-	terminal.
21	CAP2+	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP2+terminal.
22	V1	
23	V2	This is a multi-level power supply for the liquid crystal drive. The voltage
24	V3	Supply applied is determined by the liquid crystal cell, and is changed through the
25	V4	use of are sistive voltage divided or through changing the impedance using an op. amp. Voltage levels are determined based on VDD,
26	V5	amp. Voltage levels are determined based on VDD,
27	VR	Output voltage regulator terminal. Provides the voltage between VDD and V5 through a resistive voltage divider. IRS = "L": the V5 voltage regulator internal resistors are not used. IRS = "H": the V5 voltage regulator internal resistors are used.
28	C86	This is the MPU interface switch terminal. C86 = "H": 6800 Series MPU interface. C86 = "L": 8080 MPU interface.
29	P/S	This is the parallel data input/serial data input switch terminal. P/S = "H": Parallel data input. P/S = "L": Serial data input. When P/S = "L", D0 to D5 fixed "H". /RD (E) and /WR (R/W) are fixed to either "H" or "L". With serial data input, It is impossible read data from RAM.
30	IRS	This terminal selects the resistors for the V5 voltage level adjustment. IRS = "H": Use the internal resistors IRS = "L": Do not use the internal resistors. The V5 voltage level is regulated by an external resistive voltage divider attached to the VR terminal

8.Contour Drawing



9.Reliability

Content of Reliability Test (Wide temperature, -20°c~70°C)

Environmental Test						
Test Item	Content of Test	Test Condition	Not e			
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2			
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2			
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs				
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1			
High Temperature/ Humidity storage	The module should be allowed to stand at 60 °C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2			
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C 30min 5min 30min 1 cycle	-20°C/70°C 10 cycles	_			
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3			
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±600V(contact), ±800v(air), RS=330Ω CS=150pF 10 times				

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

10.Backlight Information

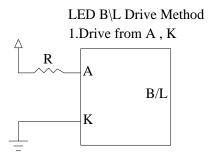
Specification

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	ILED	15	40	60	mA	V=5.0V(Note 1)
Supply Voltage	V	_	5.0	_	v	_
Reverse Voltage	VR	_	_	5	v	_
Colour	X	0.26	_	0.32	_	_
Coordinate	Y	0.26	_	0.32	_	_
Luminance	IV	800	1000		ad/m²	ILED=40mA
(Without LCD)	1 V	auu	1000		Cu/III	ILED=40IIIA
LED Life Time						ILED=40mA
(For Reference	_	_	50K	_	Hr.	25℃,50-60%RH,
only)						(Note 2)
Color	White					

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

Note 1: Supply current minimum value is only for reference since LED brightness efficiency keeps enhancing. Current consumption becomes less and less to achieve the same luminance.

Note 2:50K hours is only an estimate for reference.



11.Inspection specification

NO	Item	Criterion				AQL	
01	Electrical Testing	Missing vertical, horizontal segment, segment contrast defect. Missing character, dot or icon. Display malfunction. No function or no display. Current consumption exceeds product specifications. LCD viewing angle defect. Mixed product types. Contrast defect.					
02	Black or white spots on LCD (display only)	three white or black spots p		present.	on display ≤ 0.25 mm, no more than present. ore than two spots or lines within 3mm		
03	LCD black spots, white spots, contamination (non-display)	3.1 Round type $\Phi=(x+y)/2$ X 3.2 Line type : (↓ ▼ Y	SIZE $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi$	Acceptable Q TY Accept no dense 2 1 0 Acceptable Q TY Acceptable Q TY Accept no dense 2 As round type	2.5	
04	Polarizer bubbles	If bubbles are very judge using black specifications, reto find, must characteristics.	ck spot not easy eck in	Size Φ $\Phi \le 0.20$ $0.20 < \Phi \le 0.50$ $0.50 < \Phi \le 1.00$ $1.00 < \Phi$ Total Q TY	Acceptable Q TY Accept no dense 3 2 0 3	2.5	

NO	Item	Criterion					
05	Scratches	Follow NO.3 LCD black spots, white spots, contamination					
			Glass thickness a: LC	ip thickness CD side length			
		6.1 General glass chip: 6.1.1 Chip on panel surface and crack between panels:					
		z: Chip thickness	y: Chip width	x: Chip length			
06	Chipped	Z≦1/2t	Not over viewing area	x ≤ 1/8a	2.5		
00	glass	$1/2t < z \leq 2t$	Not exceed 1/3k	x ≤ 1/8a	2.3		
			y: Chip width Not over viewing area Not exceed 1/3k	of each chip. $ x: Chip \ length \\ x \leq 1/8a $ $ x \leq 1/8a $			

NO	Item	Criterion			AQL			
		Symbols:						
		x: Chip length y: Ch	ip width z: Chij	p thickness				
		k: Seal width t: Gla	ss thickness a: LCI	O side length				
		L: Electrode pad length						
		6.2 Protrusion over terminal :						
6.2.1 Chip on electrode pad :								
06	Glass		Chip length z : Chip thickness $\leq 1/8a$ $0 < z \leq t$ fon:		2.5			
		y: Chip width	x: Chip length	z: Chip thickness				
		$y \leq L$	x ≤ 1/8a	$0 < z \leq t$				
		⊙ If the chipped area touch	es the ITO terminal (
		remain and be inspected acc						
		_	_	mer, the alignment mark not				
		be damaged.		,				
		6.2.3 Substrate protuberance	e and internal crack.					
		x ¹		v. longth				
		N. Marie	y: width	x: length				
			$y \le 1/3L$	$x \leq a$				
		7.3	550					

NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
08	Backlight elements	8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards.	
09	Bezel	8.3 Backlight doesn't light or color wrong.9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.9.2 Bezel must comply with job specifications.	0.65 2.5 0.65
10	PCB · COB	10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down.	2.5 2.5 0.65 2.5 2.5 0.65
		10.9 The Scraping testing standard for Copper Coating of PCB \mathbf{X} $\mathbf{X} * \mathbf{Y} <= 2 \text{mm}^2$	2.5
11	Soldering	 11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB. 	2.5 2.5 2.5 0.65

NO	Item	Criterion	AQL
		12.1 No oxidation, contamination, curves or, bends on interface	2.5
		Pin (OLB) of TCP.	
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface	2.5
		pin must be present or look as if it cause the interface pin to sever.	
	General	12.6 The residual rosin or tin oil of soldering (component or chip	2.5
12		component) is not burned into brown or black color.	
	appearance	12.7 Sealant on top of the ITO circuit has not hardened.	2.5
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging	0.65
		specification sheet.	
		12.11 Product dimension and structure must conform to product	0.65
		specification sheet.	
		12.12 Visual defect outside of VA is not considered to be rejection.	0.65

12.Material List of Components for

RoHs

1. WINSTAR Display Co., Ltd hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	Cd	Pb	Hg	Cr6+	PBB	PBDE	DEHP	BBP	DBP	DIBP
Limited	100	1000	1000	1000	1000	1000	1000	1000	1000	1000
Value ppm ppm ppm ppm ppm ppm ppm ppm ppm pp										
Above limited value is set up according to RoHS.										

- 2.Process for RoHS requirement : (only for RoHS inspection)
 - (1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.
 - (2) Heat-resistance temp. :

Reflow: 250° C, 30 seconds Max.;

Connector soldering wave or hand soldering : 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. $: 235\pm5^{\circ}C$;

Recommended customer's soldering temp. of connector: 280°C, 3 seconds.

13. Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.

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dule	Number:			Page: 1
1 \ <u>P</u>	anel Specification:			
1.	Panel Type:	Pass	☐ NG ,	
2.	View Direction:	Pass	☐ NG ,	
3.	Numbers of Dots:	Pass	☐ NG ,	
4.	View Area:	Pass	☐ NG ,	
5.	Active Area:	Pass	☐ NG ,	
6.	Operating Temperature:	Pass	☐ NG ,	
7.	Storage Temperature:	Pass	☐ NG ,	
8.	Others:			
2 · <u>N</u>	Iechanical Specification :			
1.	PCB Size:	Pass	☐ NG ,	
2.	Frame Size:	Pass	□ NG ,	
3.	Materal of Frame:	Pass	☐ NG ,	
4.	Connector Position:	Pass		
5.	Fix Hole Position:	Pass	☐ NG ,	
6.	Backlight Position:	Pass	☐ NG ,	
7.	Thickness of PCB:	Pass	☐ NG ,	
8.	Height of Frame to PCB:	Pass	☐ NG ,	
9.	Height of Module:	Pass	☐ NG ,	
10.	Others:	☐ Pass	☐ NG ,	
3 \ <u>R</u>	Relative Hole Size :			
1.	Pitch of Connector:	☐ Pass	☐ NG ,	
2.	Hole size of Connector:	☐ Pass	□ NG ,	
3.	Mounting Hole size:	☐ Pass	□ NG ,	
4.	Mounting Hole Type:	Pass		
5.	Others:	Pass	□ NG ,	
4、 <u>B</u>	acklight Specification :			
1.	B/L Type:	Pass	☐ NG ,	
2.	B/L Color:	Pass	☐ NG ,	
3.	B/L Driving Voltage (Refere	nce for LED		☐ NG ,
4.	B/L Driving Current:	Pass		
5.	Brightness of B/L:	Pass		
	B/L Solder Method:	Pass		



	winstar		
Modu	le Number:		Page: 2
5、	Electronic Characteristics of	Module:	
1.	Input Voltage:	Pass	☐ NG ,
2.	Supply Current:	Pass	☐ NG ,
3.	Driving Voltage for LCD:	☐ Pass	□ NG ,
4.	Contrast for LCD:	Pass	□ NG ,
5.	B/L Driving Method:	Pass	□ NG ,
6.	Negative Voltage Output:	Pass	□ NG ,
7.	Interface Function:	Pass	□ NG ,
8.	LCD Uniformity:	☐ Pass	□ NG ,
9.	ESD test:	Pass	□ NG ,
10.	Others:	☐ Pass	□ NG ,
6、	Summary :		
	Sales signature :		
	Customer Signature:		Date : / /